ASSOCIATION CONNECTING LECTRONICS INDUSTRIES® INCLUSTRIES®	nnockburn, Illinois. A	ll rights reserved un ations.	nder both Ie	his docume vel parts, t	ent is a declaration he declaration er	on of the substan	ces within the manufactur wer level materials for w	rer listed iten hich the mar	n. Note: if t nufacturer h	he item is an as as engineering	sembly with lower responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form T http://www.ipc.org/IPC-175x Distribution			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and				als and Mfg	and Mfg Information			
Supplier Information												
mpany name* Company unique ID			Unique		Unique ID Autho	ique ID Authority			Response Date*			
onsemi	mi								2023-06-08			
Contact Name	Title - Contact			Phone - Contact*				Email - Contact*				
duct-Env-Stewards Product Enviro Compliance				NA			Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - Representative				Phone - Representative*				Email - Representative*				
Product-Env-Stewards Product Enviro Compliance			nce		NA			Product-Env-Stewards@onsemi.com				
Requester Item Number M	lfr Item Number	Mfr Item Name			Effective Date	Version	Manufacturing Site		eight*	UOM	Unit Type	
M	IAX810SQ120T1G	X810SQ120T1G ANA 1.20V MCI			2023-06-08 MY1		MY1	6.0	•	mg	Each	
Manufacturing Proccess Information		-			•	·	·				-	
Terminal Plating / Grid Array Material	Terminal Base A	Alloy J-	-STD-020 MSL R	Rating	Peak Proce	Process Body Temperature Max Time at Peak		Temperature Number of Reflow Cycles		les		
Matte Tin (Sn) - annealed CU Alloy 1				260	С	30	seconds	3				
Comments												
level 1 - maximum time at peak temperature dur	ring soldering is 10-3	0 seconds										
For more information regarding material compo	sition please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	HS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead b), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl thalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).								
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of				
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted				
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the				
Supplier Digital Signature Ra	stislav Drska	Le							

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.1	mg	Supplier	Silicon (Si)	7440-21-3		0.1	mg
Die Attach	0.15	mg	Supplier	Silver (Ag)	7440-22-4		0.1125	mg
			Supplier	Epoxy resins	129915-35-1		0.0375	mg
Lead Frame	1.93	mg	В	Nickel (Ni)	7440-02-0		0.7392	mg
			Supplier	Iron (Fe)	7439-89-6		1.021	mg
			Supplier	Copper (Cu)	7440-50-8		0.1698	mg
Mold Compound-Black	3.7	mg		Epoxy resin	proprietary data		0.185	mg
			Supplier	Phenolic Resin	Proprietary Data		0.185	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.074	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0185	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		3.2375	mg
Plating	0.11	mg	Supplier	Tin (Sn)	7440-31-5		0.11	mg
Wire Bond - Au	0.01	mg	Supplier	Gold (Au)	7440-57-5		0.01	mg